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# 1/2.88" Color CMOS 50MP (8192 x 6144) Image Sensor with PureCel®Plus-S Technology

The OV50D combines 50MP resolution and 0.612 µm pixel size in a small 1/2.88-inch optical format for smartphone cameras. 4-cell binning delivers premium video and preview quality in 12.5MP mode, especially in low light. The OV50D features staggered HDR, always-on ALS support, and ultra low power modes.

The OV50D can achieve up to 62x analog gain for 4-cell binning resolution. Built on OMNIVISION's PureCel®Plus-S stacked die technology, the OV50D can also use near-pixel

binning to output a 12.5MP image or 4K2K video with two times the sensitivity, yielding 1.22  $\mu m$ -equivalent performance for preview and video.

The OV50D supports type 2 2x2 ML phase detection autofocus. The OV50D supports the CPHY/DPHY MIPI interface and dual DOVDD 1.8/1.2V.

Find out more at www.ovt.com.



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# **OV50D**

#### **Ordering Information**

 OV50D40-GA5A-002A-Z (color, chip probing, 150 µm backgrinding, reconstructed wafer with good die)

#### Applications

- mobile wide camera
- mobile ultrawide camera

### **Technical Specifications**

- active array size: 8192 x 6144
- maximum image transfer rate: 12.5MP (4096 x 3072): 48 fps
- 9MP (4096 x 2304): 60 fps
- power supply:
- core: 1.1V

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- analog: 2.8V - I/O: 1.8V or 1.2V
- power requirements:
- active: 380 mW (12MP @ 48 fps) 284 mW (12MP @ 30 fps)
- XSHUTDOWN: <50 µA
- output formats: 10-bit RGB RAW

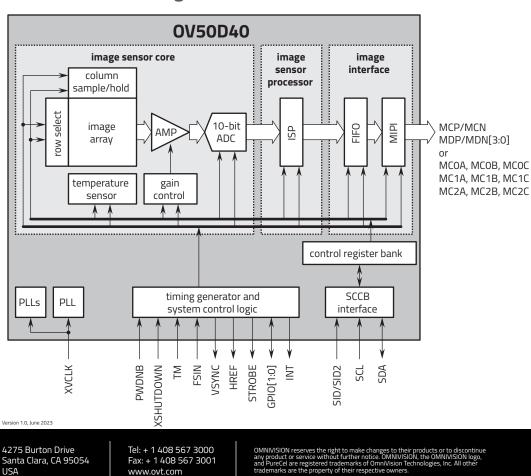
- temperature range:
  operating: -30°C to +85°C
  - junction temperature stable: 0°C to +60°C
  - junction temperature
  - temperature sensor: ±5°C between 0°C to +80°C (for higher resolutions: ±2°C between +50°C to +80°C)
- lens size: 1/2.88

video conferencing

- Iens chief ray angle: 34.38° non-linear
- scan mode: progressive
- pixel size: 0.612 μm x 0.612 μm
- image area: 5052.672 μm x 3799.296 μm

- **Product Features**
- automatic black level calibration (ABLC)
- programmable controls for:
- frame rate
- mirror and flip
- binning - cropping
- windowing
- support for dynamic DPC
- supports output formats:
- 10-bit RGB RAW for normal mode - 8-bit RGB RAW for ULP mode
- supports horizontal and vertical subsampling
- supports typical images sizes: 4096 x 3072
- 4096 x 2304
- 3840 x 2160 - 1920 x 1080
- 1280 x 720
- standard serial SCCB interface
- up to 4-lane MIPI D-PHY interface with speed up to 2.4 Gbps/lane

- 2/3 trio C-PHY interface, up to 1.4 Gsps/trio
- supports 4-cell binning, 4-cell full, 16-cell binning, and 16-cell full
- supports type 2 2x2 ML PDAF
- 4-cell support: 4-cell binning only (RGB Bayer output)
- HDR support: stagger HDR 2 exposure
- supports always-on ALS and ULP modes
- high gain mode for binning up to 62x analog gain
- dual I/O power supply (1.2V/1.8V)
- supports fast switch mode (fast switch between different modes)
- three on-chip phase lock loops (PLLs)
- programmable I/O drive capability
- built-in temperature sensor
- 0.612 µm pixel



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## **Functional Block Diagram**

www.ovt.com